Philips Semiconductors

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T-49-19-03

80C550/83C550/87C550

CMOS single-chip 8-bit microcontroller with A/D and watchdog timer

FOR DETAILED INFORMATION SEE THE LATEST ISSUE OF HANDBOOK IC20 OR DATASHEET

DESCRIPTION

The Philips 8XC550 is a high-performance microcontroller fabricated with Philips high-density CMOS technology. This Philips CMOS technology combines the high speed and density characteristics of HMOS with the low power attributes of CMOS. Philips epitaxial substrate minimizes latch-up sensitivity. The CMOS 8XC550 has the same instruction set as the 80C51.

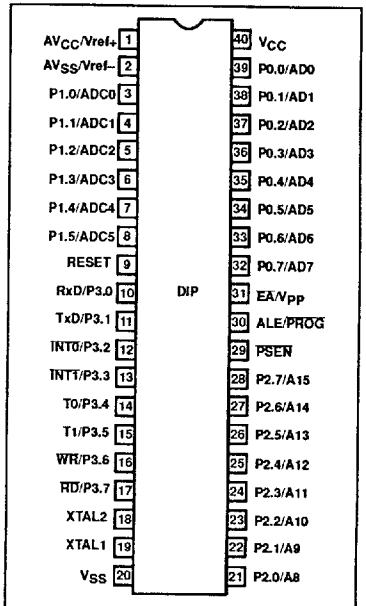
The 8XC550 contains a 4k x 8 EPROM (87C550)/ROM (83C550)/ROMless (80C550 has no program memory on-chip), a 128 x 8 RAM, 8 channels of 8-bit A/D, four 8-bit ports (port 1 is input only), a watchdog timer, two 16-bit counter/timers, a seven-source, two-priority level nested interrupt structure, a serial I/O port for either multi-processor communications, I/O expansion or full duplex UART, and an on-chip oscillator and clock circuits.

In addition, the 8XC550 has two software selectable modes of power reduction – idle mode and power-down mode. The idle mode freezes the CPU while allowing the RAM, timers, serial port, and interrupt system to continue functioning. The power-down mode saves the RAM contents but freezes the oscillator, causing all other chip functions to be inoperative.

FEATURES

- 80C51 based architecture
  - 4k x 8 EPROM (87C550)/ ROM (83C550)
  - 128 x 8 RAM
  - 8 channels of 8-bit A/D
  - Two 16-bit counter/timers
  - Watchdog timer
  - Full duplex serial channel
  - Boolean processor
- Memory addressing capability
  - 64k ROM and 64k RAM
- Power control modes:
  - Idle mode
  - Power-down mode
- CMOS and TTL compatible
- Three speed ranges at V_{CC} = 5V ±10%
  - 3.5 to 12MHz
  - 3.5 to 16MHz
- Four package styles
- Extended temperature ranges
- OTP package available

PIN CONFIGURATION



Pin	Function	Pin	Function	Pin	Function
1	AV_{CC}	16	P3.2/INT0	31	P2.6/A14
2	Vref+	17	P3.3/INT1	32	P2.7/A15
3	Vref-	18	P3.4/T0	33	PSEN
4	AV_{SS}	19	P3.5/T1	34	ALE/PROG
5	P1.0/ADC0	20	P3.6/WR	35	EA/V_{PP}
6	P1.1/ADC1	21	P3.7/RD	36	P0.7/AD7
7	P1.2/ADC2	22	XTAL2	37	P0.6/AD6
8	P1.3/ADC3	23	XTAL1	38	P0.5/AD5
9	P1.4/ADC4	24	V_{SS}	39	P0.4/AD4
10	P1.5/ADC5	25	P2.0/A8	40	P0.3/AD3
11	P1.6/ADC6	26	P2.1/A9	41	P0.2/AD2
12	P1.7/ADC7	27	P2.2/A10	42	P0.1/AD1
13	RESET	28	P2.3/A11	43	P0.0/AD0
14	P3.0/RxD	29	P2.4/A12	44	V_{CC}
15	P3.1/TxD	30	P2.5/A13		

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PART NUMBER SELECTION

ROMless	ROM	EPROM	TEMPERATURE AND PACKAGE	FREQUENCY
P80C550BBF	P83C550BBF	P87C550BBF	0 to +70°C, ceramic DIP	3.5 to 12MHz
P80C550EBF	P83C550EBF	P87C550EBF	0 to +70°C, ceramic DIP	3.5 to 16MHz
P80C550BBK	P83C550BBK	P87C550BBK	0 to +70°C, ceramic LCC	3.5 to 12MHz
P80C550EBK	P83C550EBK	P87C550EBK	0 to +70°C, ceramic LCC	0.5 to 16MHz
P80C550BBP	P83C550BBP	P87C550BBP	0 to +70°C, plastic DIP	3.5 to 12MHz
P80C550EBP	P83C550EBP	P87C550EBP	0 to +70°C, plastic DIP	3.5 to 16MHz
P80C550BBA	P83C550BBA	P87C550BBA	0 to +70°C, plastic LCC	3.5 to 12MHz
P80C550EBA	P83C550EBA	P87C550EBA	0 to +70°C, plastic LCC	3.5 to 16MHz
P80C550BFP	P83C550BFP	P87C550BFP	–40 to +85°C, plastic DIP	3.5 to 12MHz
P80C550EFP	P83C550EFP	P87C550EFP	–40 to +85°C, plastic DIP	3.5 to 16MHz
P80C550BFA	P83C550BFA	P87C550BFA	–40 to +85°C, plastic LCC	3.5 to 12MHz
P80C550EFA	P83C550EFA	P87C550EFA	–40 to +85°C, plastic LCC	3.5 to 16MHz
P80C550BFF	P83C550BFF	P87C550BFF	–40 to +85°C, ceramic DIP	3.5 to 12MHz
P80C550EFF	P83C550EFF	P87C550EFF	–40 to +85°C, ceramic LCC	3.5 to 12MHz
P80C550BFK	P83C550BFK	P87C550BFK	–40 to +85°C, ceramic LCC	3.5 to 16MHz
P80C550EFK	P83C550EFK	P87C550EFK	–40 to +85°C, ceramic DIP	3.5 to 16MHz

BLOCK DIAGRAM